

Lonten N-channel 80V, 45A, 22mΩ Power MOSFET

Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- $80V,45A,R_{DS(ON).max}=22m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- ♦ 100% EAS Guaranteed
- ◆ Green device available

Applications

- Motor Drives
- UPS
- DC-DC Converter

Product Summary

 $\begin{array}{ll} V_{DSS} & 80V \\ R_{DS(on).max} @ V_{GS} \text{=} 10V & 22m\Omega \\ I_D & 45A \end{array}$

Pin Configuration



TO-220



N-Channel MOSFET

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	80	V
Continuous drain current (T _C = 25°C)		45	A
Continuous drain current (T _C = 100°C)	l _D	28	Α
Pulsed drain current ¹⁾	I _{DM}	180	A
Gate-Source voltage	V _{GSS}	±20	V
Avalanche energy ²⁾	Eas	64	mJ
Power Dissipation (T _C = 25°C)	P _D	92	W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	TJ	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	Rejc	1.36	°C/W

Package Marking and Ordering Information



Device	Device Package	Marking
LNC08R220	TO-220	LNC08R220

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit	
Static characteristics						•	
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	80			V	
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1	1.6	2.5	V	
		V _{DS} =80V, V _{GS} =0V, T _J = 25°C			1	μΑ	
Drain-source leakage current	IDSS	V _{DS} =64V, V _{GS} =0V, T _J = 125°C			10	μΑ	
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20V, V _{DS} =0 V			100	nA	
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20V, V _{DS} =0 V			-100	nA	
Duein course on state resistance	Б	V _{GS} =10V, I _D =30A		17	22	mΩ	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =20A		22	29	mΩ	
Forward transconductance	g fs	g_{fs} $V_{DS} = 5V$, $I_D = 30A$		40		S	
Dynamic characteristics							
Input capacitance	Ciss	\/ 05\/ \/ 0\/		2200			
Output capacitance	Coss	$V_{DS} = 25V, V_{GS} = 0V,$ $V_{DS} = 100$		130		pF	
Reverse transfer capacitance	C _{rss}	- F = 1WIDZ		101			
Turn-on delay time	t _{d(on)}			7.6		ns	
Rise time	t _r	$V_{DD} = 40V, V_{GS} = 10V, I_{D} = 20A$		14			
Turn-off delay time	t _{d(off)}	VDD - 40V,VGS-10V, ID -20A		107.6			
Fall time	t _f			20.4			
Gate resistance	Rg	V _{GS} =0V, V _{DS} =0V, F=1MHz		2.2		Ω	
Gate charge characteristics							
Gate to source charge	Qgs	V 40V I 004		10.5			
Gate to drain charge	Q _{gd}	V _{DS} =40V, I _D =20A,		8.2		nC	
Gate charge total	Qg	- V _{GS} = 10V		47.6			
Drain-Source diode characteris	ics and Maxi	mum Ratings					
Continuous Source Current	Is				65	Α	
Pulsed Source Current ³⁾	Ism				260	Α	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =20A, T _J =25℃			1.2	V	
Reverse Recovery Time	t _{rr}	1 004 divit 4004 T 07%		41.6		ns	
Reverse Recovery Charge	Q _{rr}	I _S =20A,di/dt=100A/us, T _J =25℃		48.7		nC	

Notes:

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2: V_{DD}=50V, V_{GS}=10V, L=0.5mH, I_{AS}=16A, R_G=25 Ω , Starting T_J=25 $^{\circ}$ C.
- 3: Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.



Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

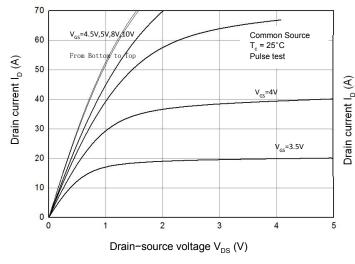


Figure 2. Transfer Characteristics

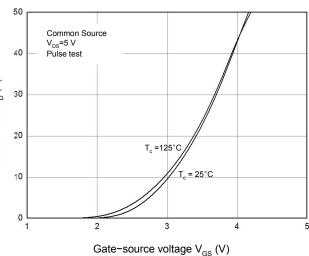


Figure 3. Capacitance Characteristics

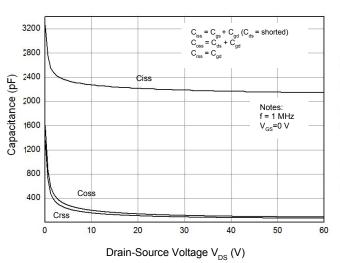


Figure 4. Gate Charge Waveform

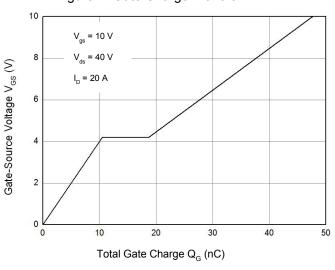


Figure 5. Body-Diode Characteristics

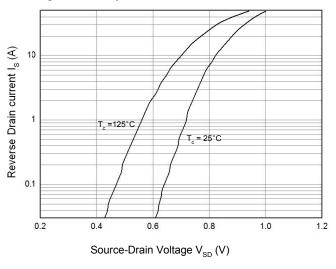
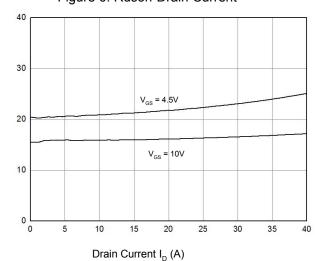


Figure 6. Rdson-Drain Current



ON-Resistance Rdson (mohm)



Figure 7. Rdson-Junction Temperature ($^{\circ}$ C)

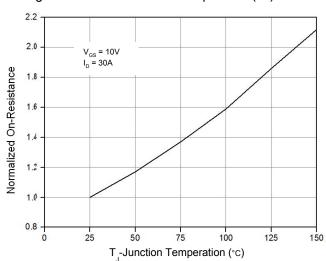


Figure 8. Maximum Safe Operating Area

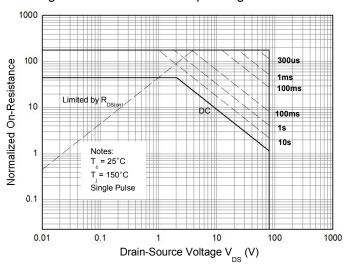
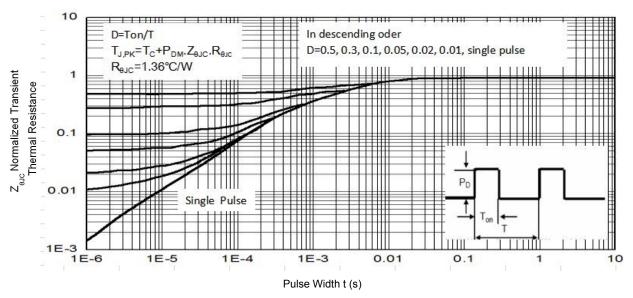


Figure 9. Normalized Maximum Transient Thermal Impedance (RthJC)

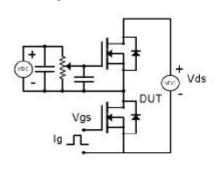


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Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform



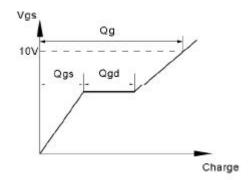
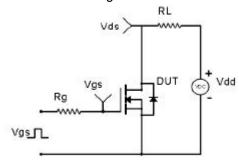


Figure 9. Resistive Switching Test Circuit & Waveforms



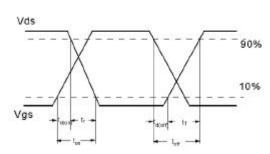
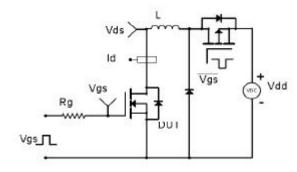


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform



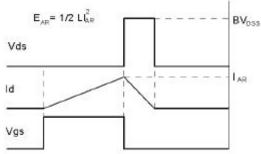
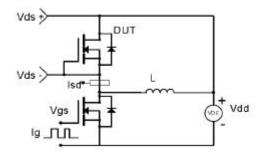
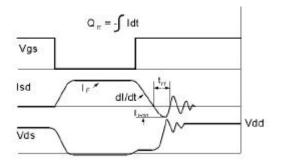


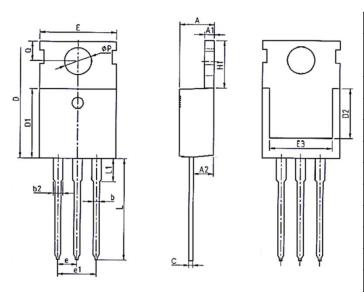
Figure 11. Diode Recovery Circuit & Waveform





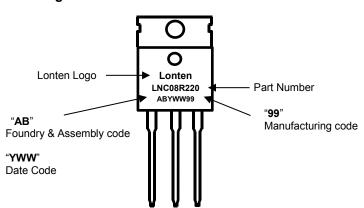


TO-220 PACKAGE INFORMATION



COMMON DIMENSIONS							
CVMDOL	MM			INCH			
SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX	
А	4.37	4.57	4.70	0.172	0.180	0.185	
A1	1.25	1.30	1.40	0.049	0.051	0.055	
A2	2.20	2.40	2.60	0.087	0.094	0.102	
b	0.70	0.80	0.95	0.028	0.031	0.037	
b2	1.17	1.27	1.47	0.046	0.050	0.058	
С	0.45	0.50	0.60	0.018	0.020	0.024	
D	15.10	15.60	16.10	0.594	0.614	0.634	
D1	8.80	9.10	9.40	0.346	0.358	0.370	
D2	5.50	-	-	0.217	-	-	
E	9.70	10.00	10.30	0.382	0.394	0.406	
E3	7.00	-	-	0.276	-	-	
е		2.54BCS 0.1BSC					
e1	5.08BCS			0.2REF			
H1	6.25	6.50	6.85	0.246	0.256	0.270	
L	12.75	13.50	13.80	0.502	0.531	0.543	
L1	-	3.10	3.40	-	0.122	0.134	
ØP	3.40	3.60	3.80	0.134	0.142	0.150	
Q	2.60	2.80	3.00	0.102	0.110	0.118	

TO-220 Part Marking Information





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